## Product Summary

| $BV_{DSS}$ | $R_{DS(ON)}$ | $I_D$ $T_C$ = +25°C |
|---|---|---|
| 650V | 0.43Ω @ $V_{GS}$ = 10V | 14A |

## Description and Applications

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high efficiency power management applications.

- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

## Features and Benefits

- Low Input Capacitance
- High $BV_{DSS}$ Rating for Power Application
- Low Input/ Output Leakage
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/**

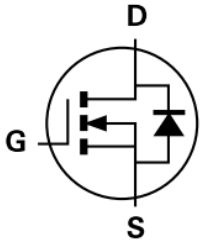
## Mechanical Data

- Case: ITO220AB-N
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ⓔ3
- Terminal Connections: See Diagram Below
- Weight: 1.9 grams (Approximate)

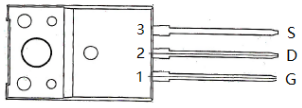
**ITO220AB-N (Type HE)**

Top View

Bottom View




Equivalent Circuit




Top View
Pin Out Configuration

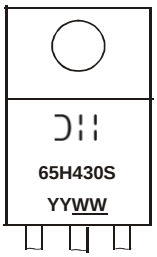
## Ordering Information (Note 4)

| Part Number | Case | Packaging |
|---|---|---|
| DMJ65H430SCTI | ITO220AB-N (Type HE) | 50 Pieces/Tube |

Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
2. See http://www.diodes.com/quality/lead_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## Marking Information

**ITO220AB-N (Type HE)**




= Manufacturer's Marking
65H430S = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 20 = 2020)
WW = Week Code (01 to 53)

## Maximum Ratings (@$T_A$ = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|---|---|---|---|---|
| Drain-Source Voltage | | $V_{DSS}$ | 650 | V |
| Gate-Source Voltage | | $V_{GSS}$ | ±30 | V |
| Continuous Drain Current (Note 5) (Note 9)<br>$V_{GS}$ = 10V | $T_C$ = +25°C<br>$T_C$ = +100°C | $I_D$ | 14<br>9 | A |
| Pulsed Drain Current (Note 5) (Note 9) | | $I_{DM}$ | 56 | A |
| Continuous Source Current (Note 5) (Note 9) | | $I_S$ | 14 | A |
| Pulsed Source Current (Note 5) (Note 9) | | $I_{SM}$ | 56 | A |
| Avalanche Current, L = 60mH (Note 6) | | $I_{AS}$ | 2 | A |
| Avalanche Energy, L = 60mH (Note 6) | | $E_{AS}$ | 120 | mJ |
| Peak Diode Recovery dv/dt (Note 6) | | dv/dt | 4 | V/ns |

## Thermal Characteristics

| Characteristic | | Symbol | Max | Unit |
|---|---|---|---|---|
| Power Dissipation (Note 7) | $T_A$ = +25°C<br>$T_A$ = +100°C | $P_D$ | 2.5<br>1 | W |
| Thermal Resistance, Junction to Ambient (Note 7) | | $R_{\theta JA}$ | 50 | °C/W |
| Power Dissipation (Note 5) | $T_C$ = +25°C<br>$T_C$ = +100°C | $P_D$ | 50<br>20 | W |
| Thermal Resistance, Junction to Case (Note 5) | | $R_{\theta JC}$ | 2.5 | °C/W |
| Operating and Storage Temperature Range | | $T_J$, $T_{STG}$ | -55 to +150 | °C |

## Electrical Characteristics (@$T_A$ = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|---|---|---|---|---|---|---|
| **OFF CHARACTERISTICS (Note 8)** | | | | | | |
| Drain-Source Breakdown Voltage | $BV_{DSS}$ | 650 | — | — | V | $V_{GS}$ = 0V, $I_D$ = 1mA |
| Zero Gate Voltage Drain Current | $I_{DSS}$ | — | — | 1 | µA | $V_{DS}$ = 650V, $V_{GS}$ = 0V |
| Gate-Source Leakage | $I_{GSS}$ | — | — | ±100 | nA | $V_{GS}$ = ±30V, $V_{DS}$ = 0V |
| **ON CHARACTERISTICS (Note 8)** | | | | | | |
| Gate Threshold Voltage | $V_{GS(TH)}$ | 2 | 3.7 | 5 | V | $V_{DS}$ = $V_{GS}$, $I_D$ = 250µA |
| Static Drain-Source On-Resistance | $R_{DS(ON)}$ | — | 0.34 | 0.43 | Ω | $V_{GS}$ = 10V, $I_D$ = 5A |
| Diode Forward Voltage | $V_{SD}$ | — | 0.86 | 1.6 | V | $V_{GS}$ = 0V, $I_S$ = 10A |
| **DYNAMIC CHARACTERISTICS (Note 6)** | | | | | | |
| Input Capacitance | $C_{iss}$ | — | 775 | — | pF | $V_{DS}$ = 100V, f = 1MHz,<br>$V_{GS}$ = 0V |
| Output Capacitance | $C_{oss}$ | — | 40 | — | | |
| Reverse Transfer Capacitance | $C_{rss}$ | — | 2.2 | — | | |
| Gate Resistance | $R_G$ | — | 2 | — | Ω | $V_{DS}$ = 0V, $V_{GS}$ = 0V, f = 1MHz |
| Total Gate Charge | $Q_g$ | — | 24.5 | — | nC | $V_{DD}$ = 520V, $I_D$ = 5A,<br>$V_{GS}$ = 10V |
| Gate-Source Charge | $Q_{gs}$ | — | 3.8 | — | | |
| Gate-Drain Charge | $Q_{gd}$ | — | 12.4 | — | | |
| Turn-On Delay Time | $t_{D(ON)}$ | — | 13 | — | ns | $V_{DD}$ = 325V, $V_{GS}$ = 10V,<br>$R_G$ = 4.7Ω, $I_D$ = 5A |
| Turn-On Rise Time | $t_R$ | — | 6 | — | | |
| Turn-Off Delay Time | $t_{D(OFF)}$ | — | 52 | — | | |
| Turn-Off Fall Time | $t_F$ | — | 37 | — | | |
| Body Diode Reverse Recovery Time | $t_{RR}$ | — | 395 | — | ns | $I_S$ = 5A, dI/dt = 100A/µs,<br>$V_{DD}$ = 50V |
| Body Diode Reverse Recovery Charge | $Q_{RR}$ | — | 4.8 | — | µC | |

Notes:
5. Device mounted on infinite heatsink.
6. Guaranteed by design. Not subject to production testing.
7. Device mounted on FR-4 substrate PC board, 2oz. copper, with minimum recommended pad layout.
8. Short duration pulse test used to minimize self-heating effect.
9. Limited by maximum junction temperature.

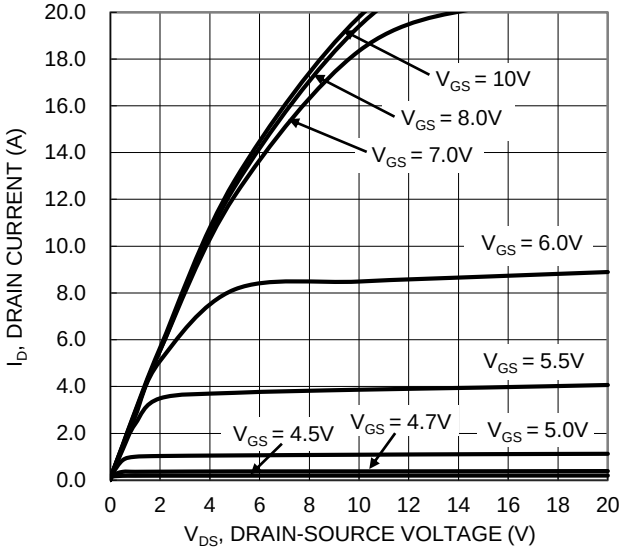



Figure 1. Typical Output Characteristic

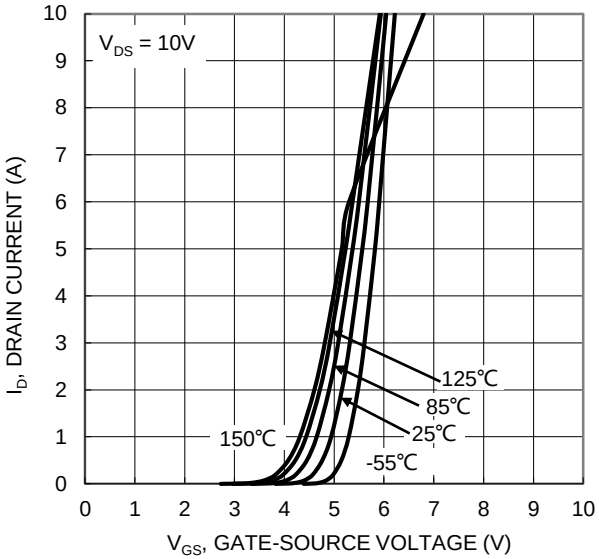



Figure 2. Typical Transfer Characteristic

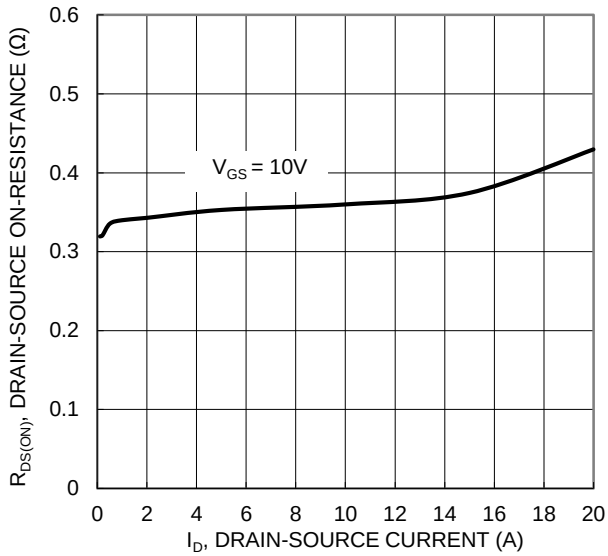



Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

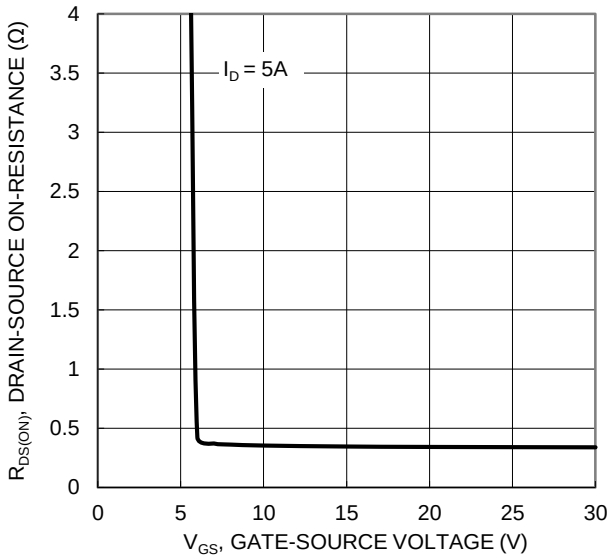



Figure 4. Typical Transfer Characteristic

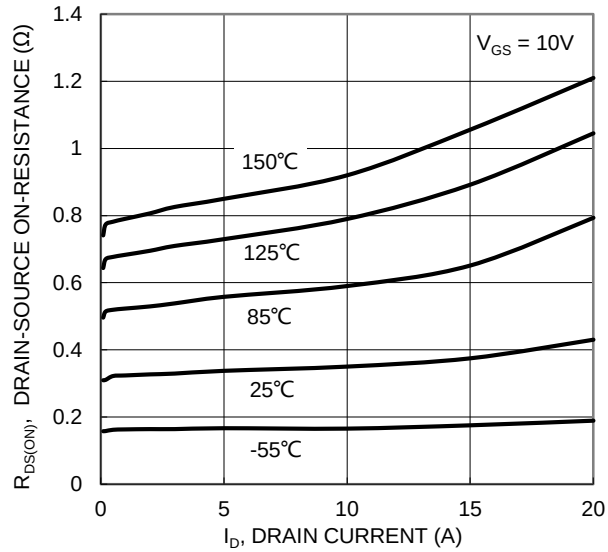



Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

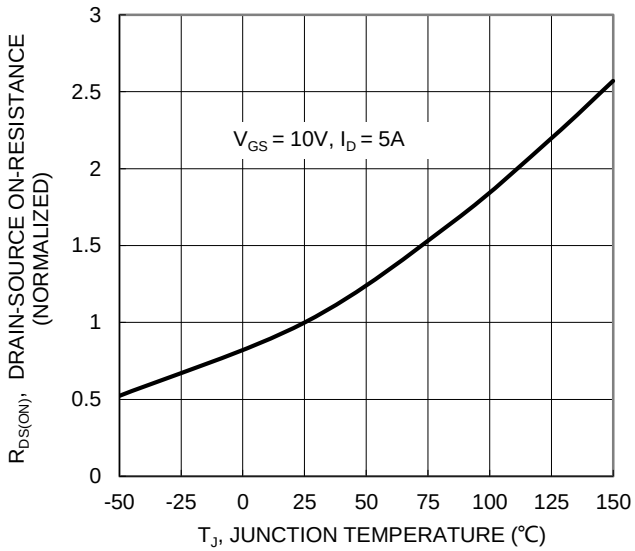



Figure 6. On-Resistance Variation with Junction Temperature

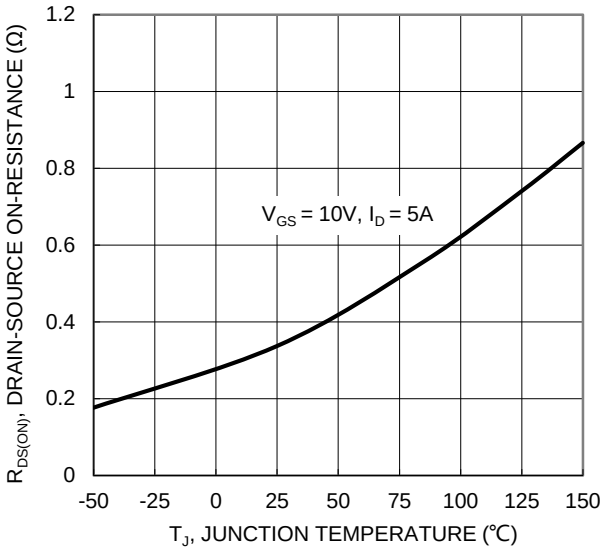



Figure 7. On-Resistance Variation with Junction Temperature

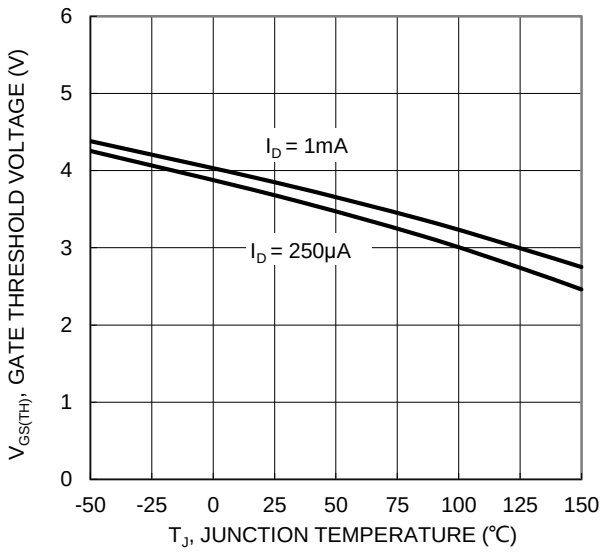



Figure 8. Gate Threshold Variation vs. Junction Temperature

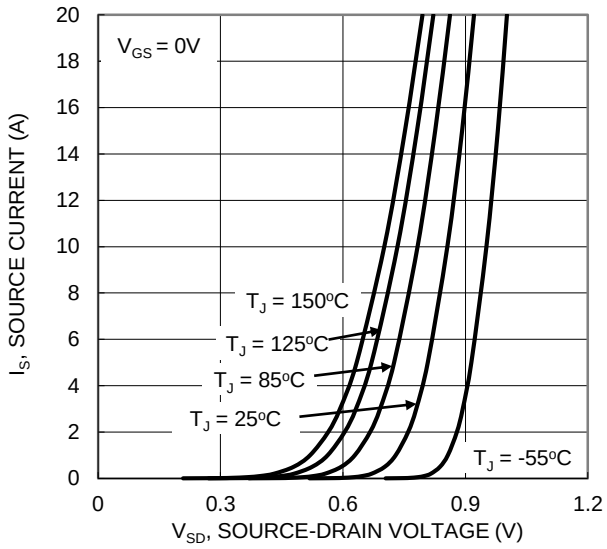



Figure 9. Diode Forward Voltage vs. Current

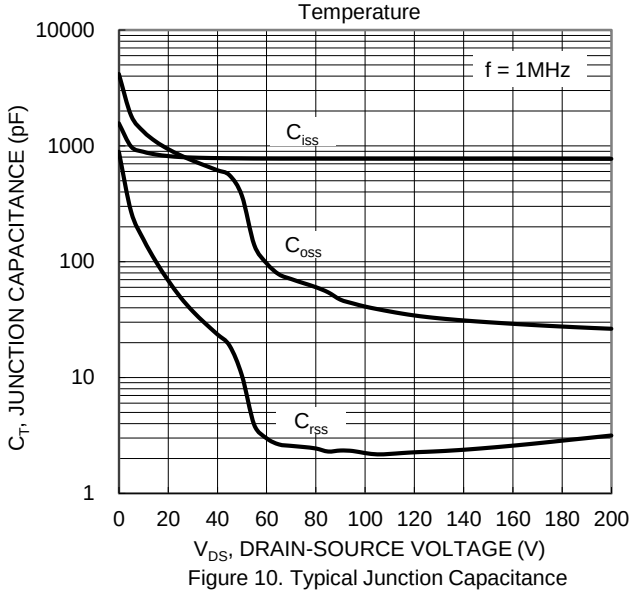



Figure 10. Typical Junction Capacitance

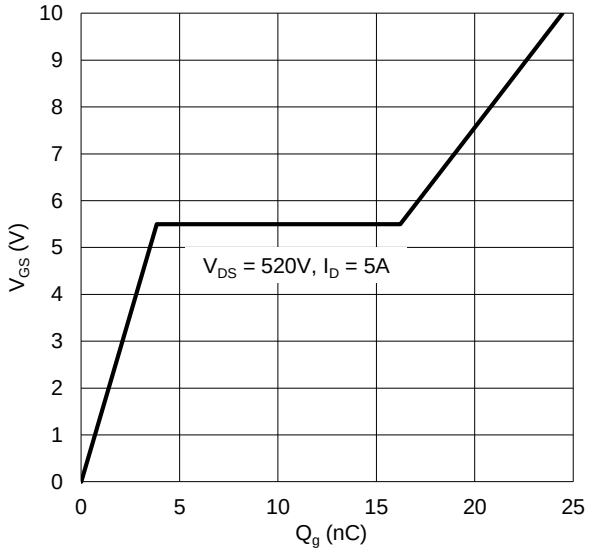



Figure 11. Gate Charge

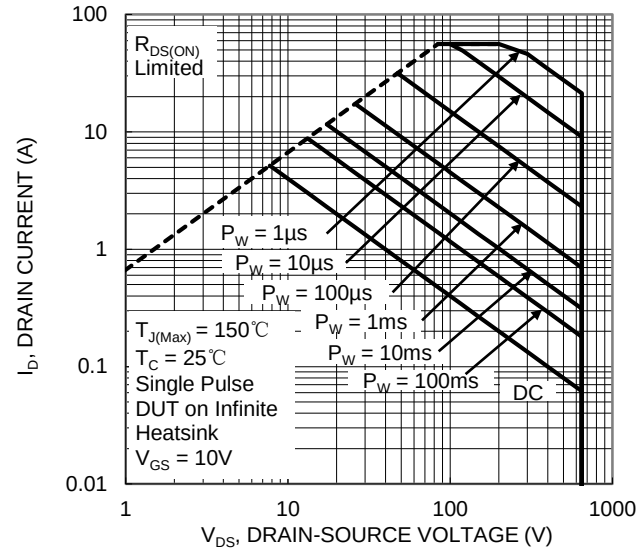



Figure 12. SOA, Safe Operation Area

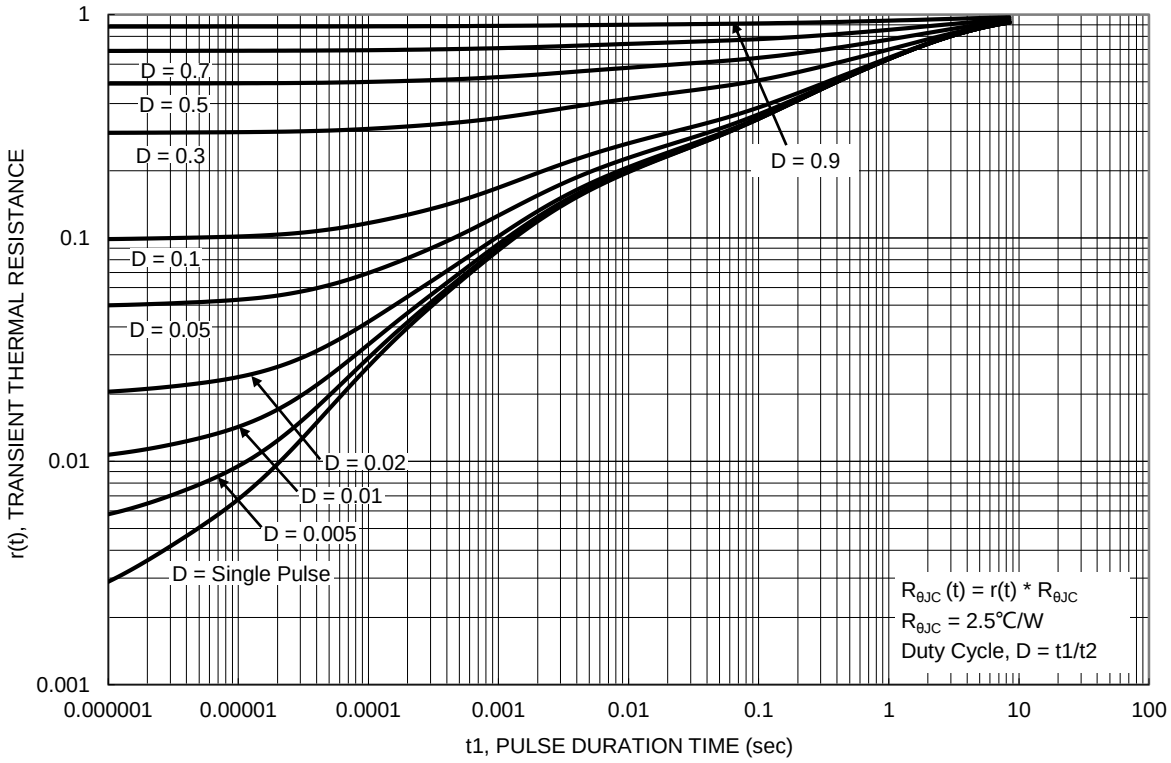
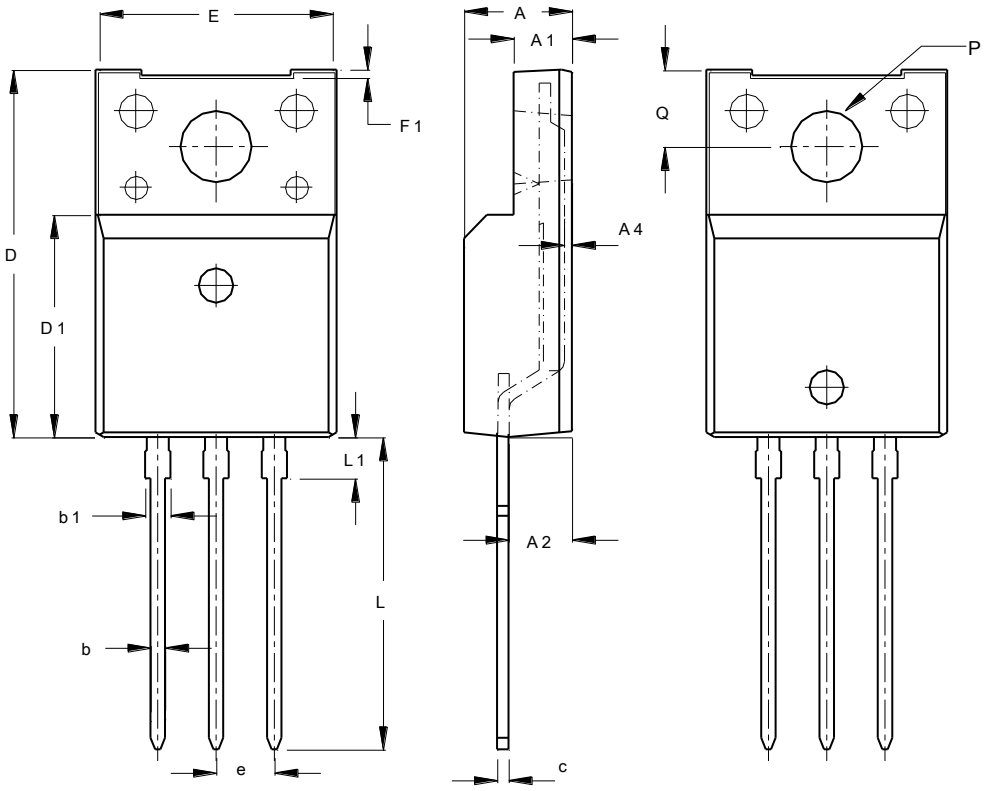



Figure 13. Transient Thermal Resistance

## Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

**ITO220AB-N (Type HE)**




| ITO220AB-N (Type HE) | | | |
|---|---|---|---|
| **Dim** | **Min** | **Max** | **Typ** |
| **A** | 4.60 | 4.80 | 4.70 |
| **A1** | 2.60 | 2.80 | 2.70 |
| **A2** | 2.47 | 2.67 | 2.57 |
| **A4** | 0.30 | 0.60 | 0.45 |
| **b** | 0.57 | 0.69 | 0.63 |
| **b1** | 1.01 | 1.15 | 1.10 |
| **c** | 0.46 | 0.59 | 0.50 |
| **D** | 15.90 | 16.10 | 16.00 |
| **D1** | 9.58 | 9.78 | 9.68 |
| **e** | 2.54 BSC | | |
| **E** | 10.40 | 10.60 | 10.50 |
| **F1** | 0.20 | 0.30 | 0.25 |
| **L** | 13.45 | 13.75 | 13.60 |
| **L1** | 1.70 | 1.90 | 1.80 |
| **Q** | 3.25 | 3.45 | 3.35 |
| **ØP** | 3.00 | 3.20 | 3.10 |
| **All Dimensions in mm** | | | |

**IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

**LIFE SUPPORT**

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or

2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.



**www.diodes.com**